

## QC operation sheet

Product	Laser diode
Package	RLD90QZW3

	Ι	Flow chart				
Materials	Material	Preparatory	Main	Name of process	Used equipment &	Controlled item
	acceptance	process	Prosess	'	machine	
LD chip		1		Acceptance test	Visual	Appearance
Submount				Chips preparation	Braking machine	Appearance
				отпро резораналоги	Expander	Air pressure Temperature
		3		Acceptance test	Microscope	Appearance
			4	Die-&wire- bonding(1)	ALDW40	Temperature DB load Ultrasonic power WB load
			5			
Stem						
Ag paste		(6)		Inspection(0)		DB position Wire-pull
						resistivity Peel-off resistivity
Bondhing agent	<u> </u>		8	Die-&wire-bonding	ASDW	Temperature DB load Ultrasonic power
			9	Inspection	Microscope Tension gauge FFP standard Correct	Wire-pull resistivity DB load Facet inclination
					monitorscope	⊿xyz

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	Flow chart				Lla a di a gui in ma a n.t. 9	
Materials	Material acceptance	Preparatory process	Main Prosess	Name of process	Used equipment & machine	Controlled item
Сар			10	Can sealing	AACL	Air pressure N2 pressure Humidity
			11>	Inspection for sealing	Cutting nipper Micrometer Correct monitorscope	Weld strength Weld extrusion Degree of decentering
			12	Products burn-in test	AATB	Set temperature
					I-L characteristics (100% test)	
			13	Final measurement①	ATMS	Temperature I-V characteristics
			Marking		Positional Appearance (100% test)	
			14	Final measurement②	APFT	Temperature I-L characteristics I-V characteristics FFP Wavelength
			15	Appearance check	Microscope	Crazing and dirt of lens Flaws of stem In deposition (100% test)
			16	Quantity treatment	Calculator	Quantity check
			17)	Packing		Slip Indication check
			18	Shipment inspection		Outer label and contents check
			19	Packaging		Detailed statement for shipment Packing condition
www.rohm.com			20	Shipment		

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